

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
VIA TECHNOLOGIES, INC.	07/01/2015
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	VIA ALLIANCE SEMICONDUCTOR CO., LTD.
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<b>City:</b>	SHANGHAI
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<b>Postal Code:</b>	201203
<b>PROPERTY NUMBERS Total: 2</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14587628
<b>Application Number:</b>	14607230
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<b>SIGNATURE:</b>	/Daniel R. McClure/
<b>DATE SIGNED:</b>	09/09/2015
<b>Total Attachments: 2</b>	
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**ASSIGNMENT OF U.S. PATENTS**

WHEREAS, VIA TECHNOLOGIES, INC., having a place of business at 8F, 533, Zhongzheng Rd., Xindian Dist. New Taipei City 231, Taiwan, hereinafter referred to as ASSIGNOR, owns the full right, title, and interest in

U.S. patent application No.: 14/587,628

Filing Date: December 31, 2014

Title: DELAY LINE CIRCUITS AND SEMICONDUCTOR INTEGRATED CIRCUITS

And it's divisional application:

U.S. patent application No.: 14/607,230

Filing Date: January 28, 2015

Title: DELAY LINE CIRCUITS AND SEMICONDUCTOR INTEGRATED CIRCUITS

WHEREAS, VIA ALLIANCE SEMICONDUCTOR CO., LTD., having a place of business at Room 301, No.2537, Jinke Road, Zhangjiang Hi-Tech Park, Shanghai 201203, P.R. China, hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in and to said invention and any U.S. provisional, continuation, continuation-in-part, divisional, reissued, re-examined, and any foreign applications and patents, to be filed or issued, relating to said invention.

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged by ASSIGNOR, ASSIGNOR has sold, assigned and transferred and does hereby sell, assign and transfer unto ASSIGNEE, and ASSIGNEE'S successors and assigns, (a) the entire right, title and interest, for the United States of America, in and to said invention and all the rights and privileges in any application and under any and all patents that may be granted in the U.S. for the invention, including but not limited to, all corresponding provisional, continuation, continuation-in-part, divisional, reissue, and reexamination applications; and (b) the entire right, title and interest in and to any and all foreign patents and applications for any invention described in said U.S. patent applications, in any and all countries foreign to the U.S., including all rights of priority arising from them, and all the rights and privileges under any and all forms of protection, including patents, that may be granted in said countries foreign to the U.S. for them; and (c) the right to seek remedies for any and all infringements of any of the foregoing patents and to collect and retain all damages and profits and enjoy any and all remedies granted for infringements.

ASSIGNOR authorizes ASSIGNEE to make any and all application for such protection in its own name and maintain such protection in any and all countries foreign to the U.S., and to invoke and claim for any application for patent or other form of protection for any said invention, without further authorization

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from ASSIGNOR, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

ASSIGNOR hereby consents that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of ASSIGNEE to apply for patent protection for said invention or other form of protection for said invention and to claim the aforesaid benefit of the right of priority.

VIA TECHNOLOGIES, INC.

By: 

Name: Wen-Chi CHEN

Title: President

Date: July 1, 2015

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